Tyrone Camarero Specifications



Camerero: SDI200C3S-436H

Key Feature

Enterprise Server, iSCSI SAN, HPC, Data Center, Database Processing & Storage, Corporate Database, Appliance Optimized Storage Building Blocks

- Dual Socket E (LGA-4677), 5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable processors
- Up to 4TB 3DS ECC RDIMM, DDR5-4800MT/s(1DPC) in 16 DIMM slots
- 1x GbE Dedicated LAN for server remote management: IPMI 2.0 / KVM over LAN / Media over LAN
- 2x 10 GbE onboard via Broadcom BCM57416
- 4 PCle 5.0 x16 (in x16) LP slot(s), 2 PCle 5.0 x8 (in x8) LP slot(s)
- 36x 3.5"/2.5" Hot-swap SAS3/SATA3 drives, 2x Rear 2.5" SATA Slots, 2x SATA/N-VMe M.2 (form factor: 2280 and 22110)
- 7x 8cm hot-swap counter-rotate redundant PWM cooling fans
- 1600W Redundant Power Supplies Titanium Level (96%)
- HW RAID support via Broadcom® 3908





Processor/Cache

Processor Dual Socket E (LGA-4677), 5th Gen Intel®

Xeon® / 4th Gen Intel® Xeon® Scalable

processors

Chipset

Chipset Intel® C741 chipset

System Memory

Memory Capacity 16 DIMM slots, Up to 4TB: 16x 256 GB DRAM, Memory Type: 4800MHz ECC

DDR5 RDIMM

Expansion Slot

PCI-Express

4 PCle 5.0 x16 (in x16) LP slot(s), 2 PCle 5.0

x8 (in x8) LP slot(s)

Integrated Onboard

Network

LAN

2x 10GbE BaseT with Broadcom BCM57416

Connectivity

1 RJ45 Dedicated IPMI LAN port, 2 Onboard

10 GbE LAN Ports

Add-on Options

Raid Card

Optional

Optical Drive

None

Front Panel

LED HDD activity, Network activity, Power status, System information (overheat/UID)

Power On/Off

Drive bays

Buttons

HDD Bays 36x 3.5" hot-swap SATA3/SAS3 drive

bays (6x 3.5" NVMe hybrid), 2 M.2 NVMe, M-Key, 2280 and 22110

Power Supply

Power Supply 800/1600W Single Output Power

Supply

Cooling System

Fans 7x 8cm heavy duty fans with optimal

fan speed control, 1 Air Shroud(s)

Form Factor

Form Factor 4U Rackmount

Dimensions

Dimensions Height -7", Width -17.2", Depth -27.5"

Email: Info@tyronesystems.com
For more/current product information, Visit
www.tyronesystems.com

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